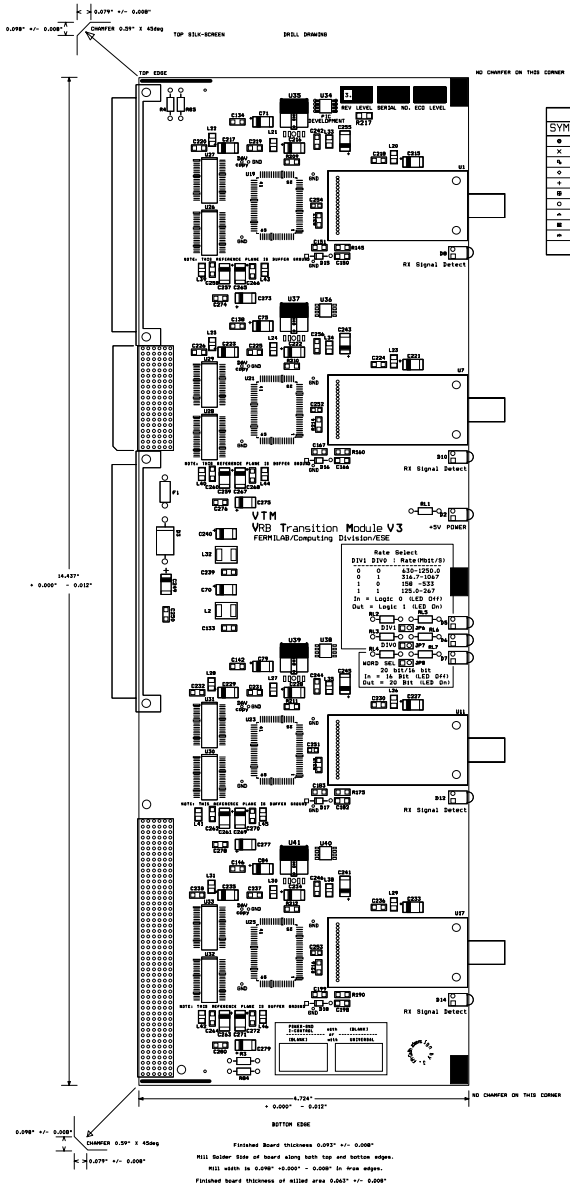

HOLE LEGEND				
SYM	DIAM	TOL	QTY	NOTE
●	0.016		665	
×	0.020		30	
↯	0.024		68	
◇	0.025		396	
+	0.035		8	
⊠	0.038		60	
○	0.057		2	
⌃	0.060		2	
■	0.090		8	
⌁	0.100		5	
TOTAL			1248	

STACKUP

2 or COPPER OUTER LAYERS, 1 or COPPER INTERNAL LAYERS
BOARD MATERIAL FR-4 FIBERGLASS
LAYER STACKUP:

LAYER 1: TOP/PADS 50 OHM CONTROLLED IMPEDANCE +/- 20%
LAYER 2: UNIVERSAL GND
LAYER 3: SIGNAL A 100 OHM CONTROLLED IMPEDANCE +/- 20%
LAYER 4: UNIVERSAL GND
LAYER 5: SIGNAL B 100 OHM CONTROLLED IMPEDANCE +/- 20%
LAYER 6: UNIVERSAL GND
LAYER 7: VCC PLANE
LAYER 8: VCC PLANE
LAYER 9: UNIVERSAL GND
LAYER 10: SIGNAL C 100 OHM CONTROLLED IMPEDANCE +/- 20%
LAYER 11: UNIVERSAL GND
LAYER 12: SIGNAL D 100 OHM CONTROLLED IMPEDANCE +/- 20%
LAYER 13: UNIVERSAL GND
LAYER 14: BOTTOM PADS

FINISHED BOARD THICKNESS 0.093" +/- .008"

Finished Board thickness 0.093" +/- 0.008"

Mill Solder Side of board along both top and bottom edges.

Mill width is 0.098" +0.000" - 0.008" in from edges.

Finished board thickness of milled area 0.063" +/- 0.008"

BOTTOM SILK-SCREEN